imall

Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from, Europe, America and south Asia, supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of "Quality Parts, Customers Priority, Honest Operation, and Considerate Service", our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip, ALPS, ROHM, Xilinx, Pulse, ON, Everlight and Freescale. Main products comprise IC, Modules, Potentiometer, IC Socket, Relay, Connector. Our parts cover such applications as commercial, industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



Contact us

Tel: +86-755-8981 8866 Fax: +86-755-8427 6832 Email & Skype: info@chipsmall.com Web: www.chipsmall.com Address: A1208, Overseas Decoration Building, #122 Zhenhua RD., Futian, Shenzhen, China





SERIES: HSE-BX-045H | DESCRIPTION: HEAT SINK

FEATURES

- TO-220 package
- placement pins for secure PCB attachment
- round hole for component attachment
- multiple available cut lengths





MODEL						power dissipation ¹
	length (mm)	@ 75°C ΔT, nat conv (°C/W)	@ 1 W, nat conv (°C/W)	@ 1 W, 200 LFM (°C/W)	@ 1 W, 400 LFM (°C/W)	@ 75°C ∆T, nat conv (W)
HSE-B254-045H	25.4	11.72	16.12	3.86	2.52	6.40
HSE-B381-045H	38.1	7.58	8.52	2.63	1.82	9.90
HSE-B508-045H	50.8	8.06	10.52	4.38	2.89	9.30
HSE-B635-045H	63.5	6.41	7.99	3.53	2.49	11.70

Note: 1. See performance curves for full thermal resistance details.

2. Custom cut to length options available. Thermal data not available on custom lengths.

PERFORMANCE CURVES

HSE-B254-045H

	Heatsink Temperature Rise Above Ambient (ΔT = Ths - Ta) (°C)			
Power (W)	Natural Conv.	200 LFM	400 LFM	
0	0	0	0	
1	16.12	3.86	2.52	
2	29.41	8.30	5.68	
3	40.00	12.22	9.31	
4	51.44	16.39	12.14	
5	61.45	20.66	15.34	
6	72.61	24.92	18.41	
7	80.92	28.68	20.86	
8	90.03	33.22	23.73	
9	96.81	37.23	26.92	
10	105.60	41.07	30.04	

100 Without Airflow 90 200 LFM 400 LFM 80 Mounting Surface Temperature Rise Above Ambient (°C) 70 60 50 40 30 20 10 0 5 6 8 9 10 3 4 7 Dissipated Power (W)

.....

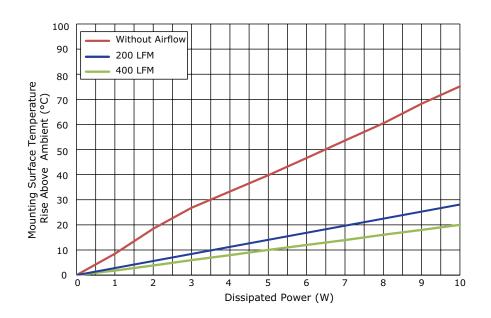
Ths: "hot spot" temperature measured on the heatsink Ta: ambient temperature

.....

PERFORMANCE CURVES (CONTINUED)

HSE-B381-045H

	Heatsink Temperature Rise Above Ambient (ΔT = Ths - Ta) (°C)			
Power (W)	Natural Conv.	200 LFM	400 LFM	
0	0	0	0	
1	8.52	2.63	1.82	
2	18.47	5.51	3.87	
3	26.83	8.39	5.96	
4	33.30	11.14	7.95	
5	39.77	13.92	10.01	
6	46.62	16.71	12.03	
7	53.59	19.45	13.95	
8	60.45	22.41	16.05	
9	68.22	25.10	17.98	
10	75.13	28.11	20.06	



Ths: "hot spot" temperature measured on the heatsink Ta: ambient temperature

HSE-B508-045H

	r			
	Heatsink Temperature Rise Above Ambient (ΔT = Ths - Ta) (°C)			
Power (W)	Natural Conv.	200 LFM	400 LFM	
0	0	0	0	
1	10.52	4.38	2.89	
2	19.69	8.39	5.86	
3	28.40	12.74	8.86	
4	37.10	16.93	12.02	
5	44.72	21.55	14.92	
6	52.72	25.52	18.01	
7	60.03	30.14	20.94	
8	66.70	34.56	24.08	
9	73.41	38.67	26.72	
10	79.99	42.96	29.99	

100 Without Airflow 90 200 LFM 400 LFM 80 Mounting Surface Temperature Rise Above Ambient (°C) 70 60 50 40 30 20 10 0 3 5 7 8 9 10 0 2 4 6 Dissipated Power (W)

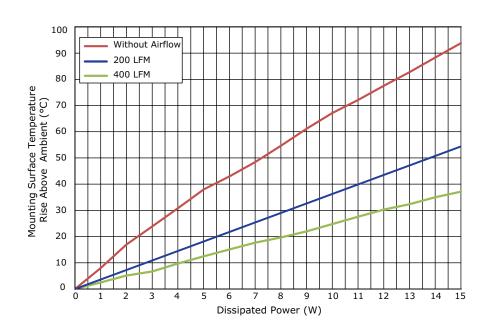
Ths: "hot spot" temperature measured on the heatsink Ta: ambient temperature

.....

PERFORMANCE CURVES (CONTINUED)

HSE-B635-045H

	Heatsink Temperature Rise Above Ambient (ΔT = Ths - Ta) (°C)			
Power (W)	Natural Conv.	200 LFM	400 LFM	
0	0	0	0	
1	7.99	3.53	2.49	
2	17.00	6.57	5.14	
3	23.87	9.99	6.67	
4	30.80	13.68	9.70	
5	37.97	17.18	12.47	
6	42.95	21.04	15.09	
7	48.42	24.72	17.68	
8	54.64	28.07	19.65	
9	61.12	31.89	21.97	
10	67.12	35.72	24.79	
11	72.12	39.54	27.58	
12	77.53	43.26	30.28	
13	82.73	46.96	32.35	
14	88.28	50.47	34.99	
15	93.81	54.37	37.14	



.....

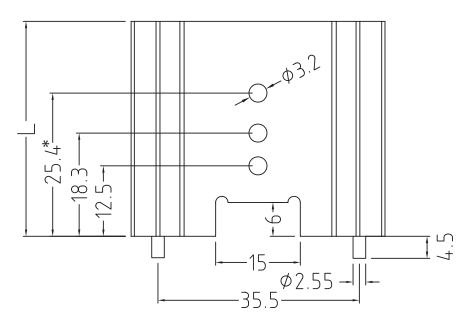
Ths: "hot spot" temperature measured on the heatsink Ta: ambient temperature

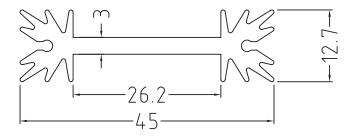
MECHANICAL DRAWING

units: mm tolerance: ±0.5 mm

MATERIAL	AL 6063-T5
FINISH	black anodized
PIN MATERIAL	steel
FINMATERIAL	SLEEP
PIN PLATING	tin

.....





MODEL NO.	LENGTH, L (mm)	WEIGHT (g)
HSE-B254-045H*	25.4	13.4
HSE-B381-045H	38.1	22.0
HSE-B508-045H	50.8	31.9
HSE-B635-045H	63.5	42.2

Note: * Mounting hole not present on 25.4 mm length model.

REVISION HISTORY

rev.	description	date
1.0	initial release	04/25/2017
1.01	updated datasheet	09/07/2017

The revision history provided is for informational purposes only and is believed to be accurate.



.....

Headquarters 20050 SW 112th Ave. Tualatin, OR 97062 800.275.4899

Fax 503.612.2383 **cui**.com techsupport@cui.com

CUI offers a one (1) year limited warranty. Complete warranty information is listed on our website.

.....

CUI reserves the right to make changes to the product at any time without notice. Information provided by CUI is believed to be accurate and reliable. However, no responsibility is assumed by CUI for its use, nor for any infringements of patents or other rights of third parties which may result from its use.

.....

CUI products are not authorized or warranted for use as critical components in equipment that requires an extremely high level of reliability. A critical component is any component of a life support device or system whose failure to perform can be reasonably expected to cause the failure of the life support device or system, or to affect its safety or effectiveness.